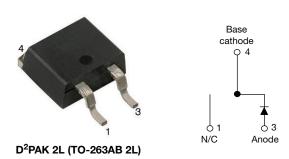


# Hyperfast Rectifier, 30 A FRED Pt® G5



#### **LINKS TO ADDITIONAL RESOURCES**





PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub> 30 A					
$V_{R}$	600 V				
V <sub>F</sub> at I <sub>F</sub> at 125 °C	1.15 V				
t <sub>rr</sub> (typ.)	25 ns				
T <sub>J</sub> max.	175 °C				
Package	D <sup>2</sup> PAK 2L (TO-263AB 2L)				
Circuit configuration	Single				

#### **FEATURES**

 Best in class forward voltage drop and switching losses trade off



- · Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- · AEC-Q101 qualified, meets JESD 201 class 1A whisker test
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

### **DESCRIPTION / APPLICATIONS**

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications.

#### **MECHANICAL DATA**

Case: D<sup>2</sup>PAK 2L (TO-263AB 2L)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Repetitive peak reverse voltage	$V_{RRM}$		600	V			
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 113 °C, D = 0.50	30	Α			
Repetitive peak forward current	$I_{FRM}$	$T_C = 113 ^{\circ}C$ , $D = 0.50$ , $f = 20  \text{kHz}$	60				
Non-repetitive peak surge current	$I_{FSM}$	$T_C = 25$ °C, $t_p = 10$ ms, sine wave	330				
Operating junction and storage temperature	$T_J$ , $T_{Stg}$		-55 to +175	°C			

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	MBOL TEST CONDITIONS		TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-	.,		
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 30 A	-	1.3	1.6	V		
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	1.15	-			
Payaraa laakaga aurrant	I <sub>R</sub>	$V_R = V_R$ rated	-	-	20			
Reverse leakage current		$T_J = 125 ^{\circ}\text{C},  V_R = V_R  \text{rated}$		500	μA			
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	-	36	-	pF		
Series inductance	L <sub>S</sub>	Measured to lead 5 mm from package body	-	8	-	nH		





<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1.0 \text{ A,dI}_F/\text{dt} =$	$I_F = 1.0 \text{ A,dI}_F/\text{dt} = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		25	-		
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	41	=	ns	
		T <sub>J</sub> = 125 °C		-	58	-	1	
Dools recovery oversent	,	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 20 A dI <sub>F</sub> /dt = 1000 A/μs - V <sub>R</sub> = 400 V	-	19	-	А	
Peak recovery current	IRRM	T <sub>J</sub> = 125 °C		-	32	-		
Deviana vacavani abava	0	T <sub>J</sub> = 25 °C		-	419	-	nC	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	1176	-		
Deviana vacavani tima		T <sub>J</sub> = 25 °C	I <sub>F</sub> = 30 A dI <sub>F</sub> /dt = 1000 A/μs V <sub>R</sub> = 400 V	-	46	-	ns	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	65	-		
Dealessessessesses		T <sub>J</sub> = 25 °C		-	21	-	A	
Peak recovery current	IRRM	T <sub>J</sub> = 125 °C		-	36	-		
Reverse recovery charge	0	T <sub>J</sub> = 25 °C		-	550	-	nC	
	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	1560	=		

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Thermal resistance, junction-to-case	R <sub>thJC</sub>		-	-	1.3	°C/W		
\A/-:- -±			-	2.0	-	g		
Weight			-	0.07	-	OZ.		
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C		
Marking device		Case style D <sup>2</sup> PAK 2L (TO-263AB 2L)	E5TH3006SH					

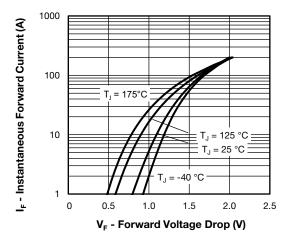


Fig. 1 - Forward Voltage Drop Characteristics, Per Leg

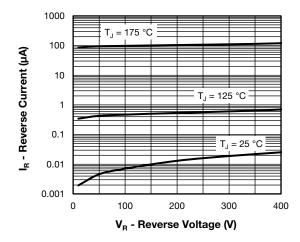


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage, Per Leg

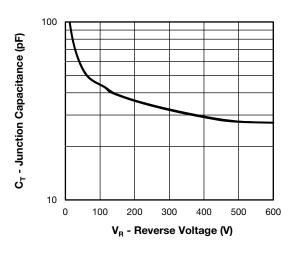


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

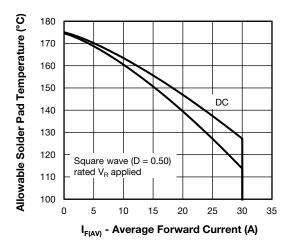


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

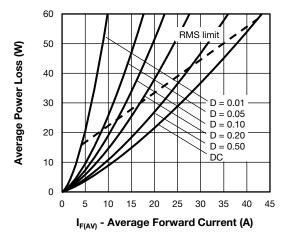


Fig. 5 - Forward Power Loss Characteristics, Per Leg



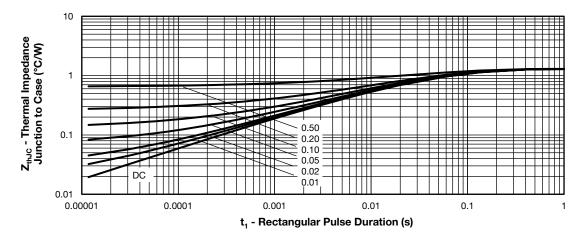


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg

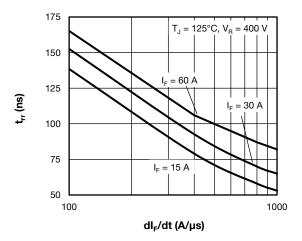


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt, Per Leg

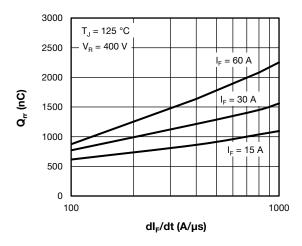


Fig. 8 - Typical Reverse Recovery Charge vs. dI<sub>F</sub>/dt, Per Leg

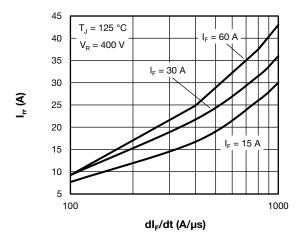


Fig. 9 - Typical Reverse Recovery Current vs. dl<sub>F</sub>/dt, Per Leg

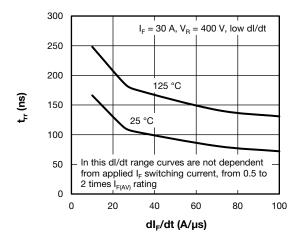
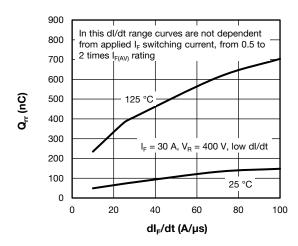


Fig. 10 - Typical Reverse Recovery Time vs. dI<sub>F</sub>/dt, Per Leg



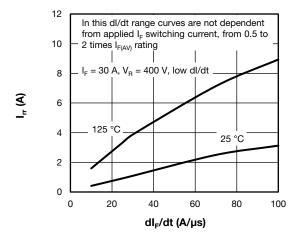


Fig. 11 - Typical Reverse Recovery Charge vs. dl<sub>F</sub>/dt, Per Leg

Fig. 12 - Typical Reverse Recovery Current vs. dl<sub>F</sub>/dt, Per Leg

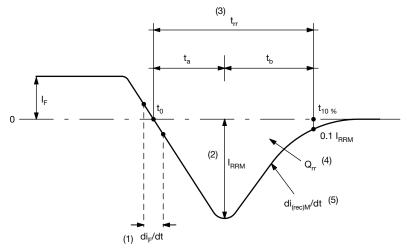


Fig. 13 - Reverse Recovery Waveform and Definitions

#### Notes

- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from t<sub>0</sub>, crossing point of negative going I<sub>F</sub>, to point t<sub>10%</sub>, 0.1 I<sub>RRM</sub>
- $^{(4)}$   $\,$   $Q_{rr}$  area under curve defined by  $t_0$  and  $t_{10}$   $_{\%}$

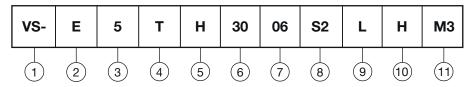
$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

(5) di<sub>(rec)</sub>M/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>



### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - E = single diode

**3** - 5 = FRED generation 5

4 - Package:

 $T = D^2PAK$  (TO-262) package

5 - H = hyperfast recovery

6 - Current rating (30 = 30 A)

7 - Voltage rating (06 = 600 V)

8 - S2 = true 2 pin  $D^2PAK$ 

9 - None = tube (50 pieces)

• L = tape and reel (left oriented, for D2PAK package)

If needed different orientation/packaging, please contact factory

10 - H = AEC-Q101 qualified

11 - Environmental digit:

M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION				
VS-E5TH3006S2LHM3	800	13" diameter reel				

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?96683			
Part marking information	www.vishay.com/doc?96693			
Packaging information	www.vishay.com/doc?95032			
SPICE model	www.vishay.com/doc?96919			



# **D<sup>2</sup>PAK 2L (TO-263AB 2L)**

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS INCHES		MILLIMETERS INCHES		NOTES
STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INC	NOTES	
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
Е	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



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